## **EE240B HW 1**

Vighnesh Iyer

February 8, 2019

## 1 HW1

- 1. For a transistor in strong inversion, the current is dominated by drift rather than diffusion. The channel profile is nevertheless non-uniform which means there is a drift current even in strong inversion. Assuming the square law model (which ignores drift) is a good estimate of the channel charge profile, calculate the diffusion current and compare it to the drift current.
- 2. For your technology DK, what is the compact model used? Which version number? Does the model use binning? If so, by which parameters?

I'm using GPDK 45nm. The compact model is BSIM v4 based. Binning is done using the  $l_{min}$ ,  $l_{max}$ ,  $w_{min}$ ,  $w_{max}$  parameters present in each model. There are 30 different bins for NMOS transistors. Binning changes  $V_{th}$ -related parameters (like vth0, lvth0, wvth0, pvth0), mobility-related parameters (like u0, lu0, wu0, pu0), subthreshold-related parameters (like voff, lvoff, wvoff, pvoff), and output resistance-related parameters (like pdiblc2, lpdiblc2).

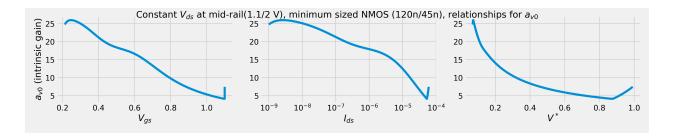
- 3. Besides W and L, what are the supported instance parameters for your model? Why are detailed layout dependent parameters (such as distance to well edge) used in some models?
  - finger width (W)
  - number of fingers (W)
  - folding threshold (finger width at which to apply device folding in layout)
  - S/D metal width (width of metal used to short source and drain)
  - some other ones I don't think matter

The layout dependent parameters are auto-derived from the basic instance parameters (I guess for the PDK-reference layout of this transistor). These layout dependent parameters can be overridden as instance parameters. These detailed layout parameters can be used to estimate device parasitics at schematic-design time.

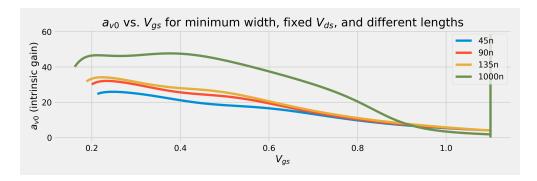
4. Set up a schematic (don't rely on the simulator to output small-signal parameters) and plot the intrinsic gain  $(a_{v0})$  of the minimum sized transistor versus  $V_{gs}$ . Make sure you hold  $V_{DS}$  constant (use an ideal op-amp - VCVS) to setup the simulation. Plot the intrinsic gain versus  $I_{ds}$  and  $V^*$ . What is your conclusion? Do you expect a strong bias current dependence? Explain.

I'm holding  $V_{DS}$  at mid rail =  $\frac{1.1}{2}$  and sweeping  $I_{ds}$ . I'm using a SVT transistor with minimum size  $(L_{min} = 45n, W_{min} = 120n)$ . Here are the plots:

EE240B HW 1 2



- $a_{v0}$  has an inverse relationship to drain current  $I_{ds}$  (logarathmic) and  $V_{gs}$  (linear)
  - This is expected because the  $r_o$  of the device decreases more rapidly than the  $g_m$  increases as  $I_{ds}, V_{gs}$  increase.
- $a_{v0}$  versus  $V^*$ , follows the  $V_{gs}$  relationship and this is one reason for using the  $V^*$  design methodology to choose the transistor's operating point.
- 5. Now re-plot the instinsic gain  $a_{v0}$  for a few non-minimum length devices. Try  $2L_{min}$ ,  $3L_{min}$ , and  $L_{max}$ . Does the gain depend on W? Explain why you should avoid using a very small W.  $L_{max}$  is the longest channel length supported by the DK.



In this process  $L_{max} = 10\mu m$ , but this gave weird simulation results, so I'm using  $L_{max} = 1\mu m$ .

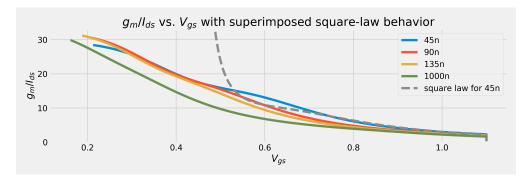
- The intrinsic gain also doesn't depend on L after the transistor is strongly saturated since the  $r_o$  vs  $g_m$  relationship begins to look similar across lengths.
- The intrinsic gain generally doesn't depend on W since  $r_o$  and  $g_m$  both scale linearly with the transistor width.
- A very small W however has a proportionally larger  $C_{dd}$  and  $C_{gg}$  than a wider transistor, which can lead to significant schematic/layout mismatches post-layout and extraction (and frequency dependent gain differences too).
- 6. Which capacitance model does your model use? What is the charge partition scheme?

  Look at capmod, xpart (in the capacitance parameter section), look these up the bsim manual
- 7. Setup a simulation to plot the normalized input capacitances seen from the gate  $(C_{gs}, C_{gd}, C_{gb})$  of a MOS device as you vary  $V_{gs}$  and hold  $V_{ds}$  constant in triode and saturation (normalize by  $C_{ox}$ ). Are the expected symmetry properties upholding? Specify as many physical constraints as possible and check to see they are upheld by the model

Hold off on this until the SS gain parameters are done.

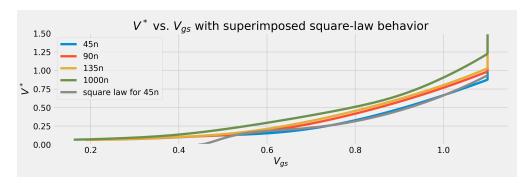
EE240B HW 1 3

8. Plot  $\frac{g_m}{I_d}$  versus  $V_{gs}$  for the minimum,  $2L_{min}$ ,  $3L_{min}$ , and  $L_{max}$  of your technology. Superimpose the expected sub-threshold and square-law behavior and compare.



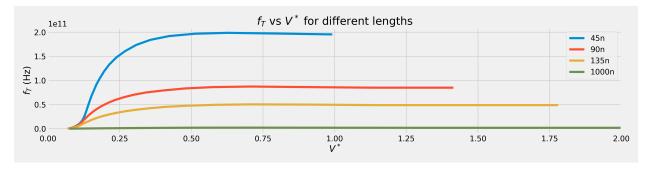
I assumed the square law was  $I_{ds} = k \frac{W}{L} (V_{gs} - V_{th})^2$ , and allowed k and  $V_{th}$  to be fitting parameters. I allowed fitting from midway through the  $I_{ds}$  sweep.

9. Plot  $V^*$  versus  $V_{gs}$  for the minimum,  $2L_{min}$ ,  $3L_{min}$ , and  $L_{max}$  of your technology. Superimpose the expected sub-threshold and square-law behavior and compare.



I used the same square-law fitting procedure. This curve makes sense since  $V^*$  is just an analog for  $V_{ov} = V_{gs} - V_{th}$ . The curved polynomial behavior indicates that at high  $V_{gs}$ ,  $V^*$  is less affected mostly due to velocity saturation.

10. Plot  $f_T$  vs  $V^*$ . Make sure to set up a schematic to extract  $f_T$  rather than using the SS-parameters of the model. Use  $L_{min}$ ,  $2L_{min}$ ,  $3L_{min}$ , and  $L_{max}$  of your technology. Explain the trends.

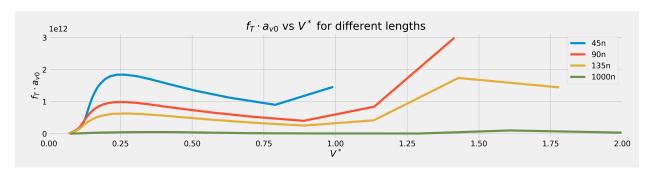


I'm extracting  $f_T$  for  $V_{ds} = 1.1/2V$  and minimum width of 120n for a SVT NMOS.  $I_{ds}$  is swept from 1n to 60u and  $V^*$  is derived from correlating this  $I_{ds}$  sweep to the previous results

EE240B HW 1 4

obtained.  $f_T$  is extracted by analyzing current gain from gate to drain and seeing at what frequency the gain drops to 0dB. Nearly 200 Ghz  $f_T$  can be obtained with the minimally sized device in this process.

11. Plot the product of  $f_T$  and  $a_{v0}$  vs  $V^*$  for  $L_{min}$ ,  $2L_{min}$ ,  $3L_{min}$ , and  $L_{max}$ . For which  $V^*$  is the product maximum for each case?



12. Design an amplifier that achieves a DC gain of 20 and a unity gain frequency of 500 Mhz while driving a load of 1pF. Specify the required  $V^*$ , bias current,  $V_{gs}$ , and device dimensions. Use the results of the previous problems to guide the design choices. Verify with SPICE.